| © Cor | erial Composit byright 2005. IPC, H ational and Pan-Am | Bannockbi | urn, Illinois. A | ll rights reserved untions. | under both | This docume level parts, t | ent is a decl the declarati | aration | of the sub compasses | ostances v all lower | vithin the level mat | manufactur erials for wl | er listed it hich the m | em. No anufact | ote: if the turer has | item is an ass engineering re | embly with lowe esponsibility. |
|--|--|------------|---------------------------|-----------------------------|------------------|--|--------------------------------|---------------------------|-------------------------|-------------------------|---------------------------------|-----------------------------|----------------------------|-------------------|--------------------------|----------------------------------|-----------------------------------|
| | IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute | | | | e * | Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi | | | | | | als and Mfg Information | | | | | |
| Supplier Information | | | | | | | | | | | | | | | | | |
| Company name* | | | Company unique ID | | | | Unique ID Authority | | | | | Response Date* | | | | | |
| onsemi | | | | | | | | | | 2024-05-16 | | | | | | | |
| Contact Name | Title - Contact | | | | Phone - Contact* | | | | | Email - Contact* | | | | | | | |
| Product-Env-Stewards | | | Product Enviro Compliance | | | NA | | | | | Product-Env-Stewards@onsemi.com | | | | | | |
| Authorized Representative* | | | Title - Representative | | | Phone - Representative* | | | | | Email - Representative* | | | | | | |
| Product-Env-Stewards | | | Product Enviro Compliance | | | NA | | | | | Product-Env-Stewards@onsemi.com | | | | | | |
| Requester Item N | Requester Item Number Mfr Iter | | n Number Mfr Item Name | | | | Effective I | Date | Version | N | Manufacturing Site | | V | Veight* | k | UOM | Unit Type |
| | CAV240 | | 512YE-GT3 | 3 512KB I2C SER EEPROM | | | 2024-05-1 | 6 | | | 31.2 | | | mg | Each | | |
| Manufacturing Procce | ss Information | | | | | | | | | | | | | | | - | · |
| Terminal Plating / Grid Array Material | | | erminal Base Alloy J-ST | | J-STD-020 MS | MSL Rating | | Peak Process Body Tempera | | mperatur | ture Max Time at Peak | | Temperature Numbe | | umber of | mber of Reflow Cycles | |
| Precious metal (e.g. Ag,Au, NiPdAu) (no Sn) | | | U Alloy | Alloy 1 | | | 260 | | | С | 30 | | seconds 3 | | | | |
| Comments | | | | | | | | | | | | | | | | | |
| evel 1 - maximum time at po | eak temperature d | uring sole | dering is 10-3 | 0 seconds | | | | | | | | | | | | | |
| or more information regard | ding material com | position p | lease refer to | page 3 | | | | | | | | | | | | | |

| RoHS Material Composition Declaration | | | | Declaration Type * | Detailed | | | | | | | |
|--|--|--|---|---|---|--|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS Directive 2011/65/EU | (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP). | | | | | | | | | | | |
| cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the | henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies | RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform | ce of its products with European Union membe | ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of | | | | | | | |
| RoHS Declaration * 1 - Item(s) | does not contain RoHS restricted substa | ances per the definitio | on above | Supplier Acceptance | * Accepted | | | | | | | |
| Exemption: If the declared item does not con applicable exemptions. | ntain RoHS restricted substances per | the definition above | except for defined RoHS exempti | ons, then select the corresponding response i | n the RoHS Declaration above and choose all | | | | | | | |
| Exemption List Version | EL-2011/534/EU | | | | | | | | | | | |
| Declaration Signature | | | | | | | | | | | | |
| Instructions: Complete all of the required fin Requester) and click on Submit Form to have | elds on all pages of this form. Select the form returned to the Requester | he "Accepted" on th | e Supplier Acceptance drop-down | . This will display the signature area. Digital | lly sign the declaration (if required by the | | | | | | | |
| Supplier Digital Signature Ra | stislav Drska | Le | | | | | | | | | | |

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Homogeneous Material | Weight | Unit of Measure | Level | Substance | CAS | Exempt | Weight | Unit of Measure |
|----------------------|--------|-----------------|----------|----------------------------|------------------|--------|---------|-----------------|
| Die | 0.66 | mg | Supplier | Silicon (Si) | 7440-21-3 | | 0.66 | mg |
| Die Attach | 0.12 | mg | Supplier | Silver (Ag) | 7440-22-4 | | 0.09 | mg |
| | | | Supplier | Epoxy resins | 129915-35-1 | | 0.03 | mg |
| Lead Frame | 10.96 | mg | Supplier | Magnesium (Mg) | 7439-95-4 | | 0.0164 | mg |
| | | | Supplier | Silicon (Si) | 7440-21-3 | | 0.0712 | mg |
| | | | В | Nickel (Ni) | 7440-02-0 | | 0.3288 | mg |
| | | | Supplier | Copper (Cu) | 7440-50-8 | | 10.5435 | mg |
| Mold Compound-Black | 19.21 | mg | | Epoxy resin | proprietary data | | 0.9605 | mg |
| | | | Supplier | Phenolic Resin | Proprietary Data | | 0.9605 | mg |
| | | | Supplier | Ortho Cresol Novolac Resin | 29690-82-2 | | 0.3842 | mg |
| | | | Supplier | Carbon Black (C) | 1333-86-4 | | 0.096 | mg |
| | | | Supplier | Fused Silica (SiO2) | 60676-86-0 | | 16.8088 | mg |
| Plating | 0.12 | mg | Supplier | Palladium (Pd) | 7440-05-3 | | 0.0075 | mg |
| | | | В | Nickel (Ni) | 7440-02-0 | | 0.1113 | mg |
| | | | Supplier | Gold (Au) | 7440-57-5 | | 0.0013 | mg |
| Vire Bond - Au | 0.13 | mg | Supplier | Gold (Au) | 7440-57-5 | | 0.13 | mg |

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).